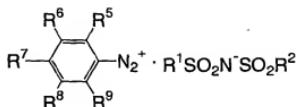


WHAT IS CLAIMED IS:

1. A heat-sensitive recording material comprising a substrate and a heat-sensitive recording layer containing a diazonium salt and a coupler, the heat-sensitive recording layer being disposed on or over the substrate, wherein the diazonium salt is a compound represented by the following general formula (1):

General formula (1)

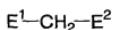


wherein R^1 and R^2 each independently represent an alkyl group or an aryl group; R^5 , R^6 , R^7 , R^8 and R^9 each independently represent one selected from the group consisting of a hydrogen atom, a chlorine atom, a bromine atom, an alkyl group, an aryl group, an alkoxy group, an aryloxy group, an acyl group, an alkoxy carbonyl group, an aryloxy carbonyl group, a carbamoyl group, a cyano group, an alkylthio group, an arylthio group, an alkylsulfonyl group, an arylsulfonyl group, an amino group, an amido group, and a nitro group; and two or more of R^1 , R^2 , R^5 , R^6 , R^7 , R^8 and R^9 may be bonded to each other to form a ring.

2. The heat-sensitive recording material of claim 1, wherein

the coupler is a compound represented by the following general formula (5):

General formula (5)



wherein E^1 and E^2 each independently represent an electron attractive group, and E^1 and E^2 may be bonded to each other to form a ring.

3. The heat-sensitive recording material of claim 1, wherein the diazonium salt is encapsulated in microcapsules.

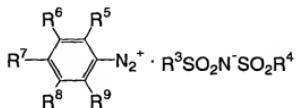
4. The heat-sensitive recording material of claim 3, wherein capsule walls of the microcapsules contain at least one of polyurethane and polyurea.

5. The heat-sensitive recording material of claim 1, wherein the diazonium salt is contained in an amount of 0.02 to 5 g/m² in the heat-sensitive recording layer.

6. The heat-sensitive recording material of claim 1, wherein the diazonium salt is contained in an amount of 0.1 to 4 g/m² in the heat-sensitive recording layer.

7. The heat-sensitive recording material of claim 1, wherein the diazonium salt is a compound represented by the following general formula (2):

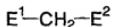
General formula (2)



wherein R³ and R⁴ each independently represent a fluoroalkyl group or a fluoroaryl group; R⁵, R⁶, R⁷, R⁸ and R⁹ each independently represent one selected from the group consisting of a hydrogen atom, a chlorine atom, a bromine atom, an alkyl group, an aryl group, an alkoxy group, an aryloxy group, an acyl group, an alkoxy carbonyl group, an aryloxy carbonyl group, a carbamoyl group, a cyano group, an alkylthio group, an arylthio group, an alkylsulfonyl group, an arylsulfonyl group, an amino group, an amido group, and a nitro group; and two or more of R³, R⁴, R⁵, R⁶, R⁷, R⁸ and R⁹ may be bonded to each other to form a ring.

8. The heat-sensitive recording material of claim 7, wherein the coupler is a compound represented by the following general formula (5):

General formula (5)



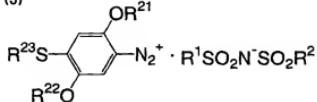
wherein E^1 and E^2 each independently represent an electron attractive group, and E^1 and E^2 may be bonded to each other to form a ring.

9. The heat-sensitive recording material of claim 7, wherein the diazonium salt is encapsulated in microcapsules.

10. The heat-sensitive recording material of claim 9,
wherein capsule walls of the microcapsules contain at least one of
polyurethane and polyurea.

11. The heat-sensitive recording material of claim 1,
wherein the diazonium salt is a compound represented by the
following general formula (3):

General formula (3)



wherein R¹ and R² each independently represent an alkyl group or an aryl group; R²¹, R²² and R²³ each independently represent an alkyl group or an aryl group; and R¹ and R² may be bonded to each other to form a ring.

12. The heat-sensitive recording material of claim 11, wherein the coupler is a compound represented by the following general formula (5):

General formula (5)



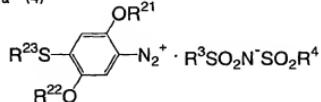
wherein E^1 and E^2 each independently represent an electron attractive group, and E^1 and E^2 may be bonded to each other to form a ring.

13. The heat-sensitive recording material of claim 11, wherein the diazonium salt is encapsulated in microcapsules.

14. The heat-sensitive recording material of claim 13, wherein capsule walls of the microcapsules contain at least one of polyurethane and polyurea.

15. The heat-sensitive recording material of claim 1, wherein the diazonium salt is a compound represented by the following general formula (4):

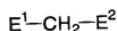
General formula (4)



wherein R³ and R⁴ each independently represent a fluoroalkyl group or a fluoroaryl group; R²¹, R²² and R²³ each independently represent an alkyl group or an aryl group; and R³ and R⁴ may be bonded to each other to form a ring.

16. The heat-sensitive recording material of claim 15, wherein the coupler is a compound represented by the following general formula (5):

General formula (5)



wherein E¹ and E² each independently represent an electron attractive group, and E¹ and E² may be bonded to each other to form a ring.

17. The heat-sensitive recording material of claim 15, wherein the diazonium salt is encapsulated in microcapsules.

18. The heat-sensitive recording material of claim 17, wherein capsule walls of the microcapsules contain at least one of polyurethane and polyurea.